

650V Super-Junction Power MOSFET

FEATURES

- $\bullet \quad \text{Very low FOM R}_{\text{DS(on)}} \times \text{Q}_{\text{g}} \\$
- 100% avalanche tested
- RoHS compliant

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



Device Marking and Package Information					
Device	TPA65R360M	TPD65R360M	TPP65R360M	TPU65R360M	
Package	TO-220F	TO-252	TO-220	TO-251	
Marking	65R360M	65R360M	65R360M	65R360M	

Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted						
Barranatar	Symbol	Value			1124	
Parameter		TO-252	TO-220	TO-251	TO-220F	Unit
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}		6	50		V
Continuous Drain Current	I _D	11		Α		
Pulsed Drain Current (note1)	I _{DM}	33		Α		
Gate-Source Voltage	V _{GSS}	±30		V		
Single Pulse Avalanche Energy (note2)	E _{AS}	215		mJ		
Avalanche Current (note1)	I _{AR}	1.8		Α		
Repetitive Avalanche Energy (note1)	E _{AR}	0.32		mJ		
Power Dissipation (T _C = 25°C)	P _D	83 31		W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150			°C	

Thermal Resistance						
Boxometox	Symphol	Value				l lm!4
Parameter	Symbol	TO-252	TO-220	TO-251	TO-220F	Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	1.5 4		°C/W		
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62 80		80	°C/VV	

V1.0 www.tsinghuaicwx.com



TPA65R360M, TPD65R360M, TPP65R360M, TPU65R360M

Wuxi Unigroup Microelectronics Company

Specifications T _J = 25°C, ur	11633 01116	Twise floted				
Parameter	Symbol Test Conditions			Value	Value	
			Min.	Тур.	Max.	
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_{D} = 250\mu A$	650			V
Zero Gate Voltage Drain Current		$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μA
Zero Gate Voltage Brain Garrent	I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 150^{\circ}C$			100	μπ
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 30V$			±100	nA
Gate-Source Threshold Voltage	$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.0	٧
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_D = 5.5A$		0.31	0.36	Ω
Forward Transconductance (Note3)	g_{fs}	$V_{DS} = 10V, I_{D} = 5.5A$		8.9		S
Dynamic				-	-	
Input Capacitance	C _{iss}	$V_{GS} = 0V$,		925		pF
Output Capacitance	C _{oss}	$V_{DS} = 50V$,		94		
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		8		
Total Gate Charge	Q_g			22		nC
Gate-Source Charge	Q_{gs}	$V_{DD} = 520V, I_{D} = 11A,$ $V_{GS} = 10V$		4		
Gate-Drain Charge	Q_{gd}	65		8		
Turn-on Delay Time	t _{d(on)}			70		
Turn-on Rise Time	t _r	$V_{DD} = 400 \text{V}, I_D = 11 \text{A},$		69		
Turn-off Delay Time	t _{d(off)}	$R_G = 25\Omega$		145		ns
Turn-off Fall Time	t _f			59		
Drain-Source Body Diode Characteris	stics					
Continuous Body Diode Current	I _s	T 0500			11	٨
Pulsed Diode Forward Current	I _{SM}	T _C = 25°C			33	Α
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}C$, $I_{SD} = 11A$, $V_{GS} = 0V$		0.9	1.2	V
Reverse Recovery Time	t _{rr}			377		ns
Reverse Recovery Charge	Q _{rr}	$V_R = 520V, I_F = I_S,$ $di_F/dt = 100A/\mu s$		7		μC
Peak Reverse Recovery Current	I _{rrm}	3. _F , 3.1 1007 0 pt0		18		А

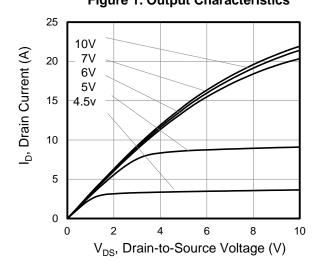
Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 1.8A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 1%



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 1. Output Characteristics



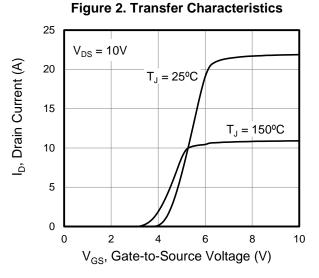
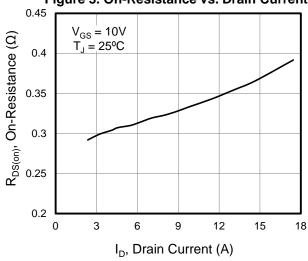


Figure 3. On-Resistance vs. Drain Current



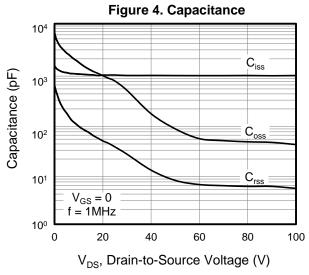


Figure 5. Gate Charge

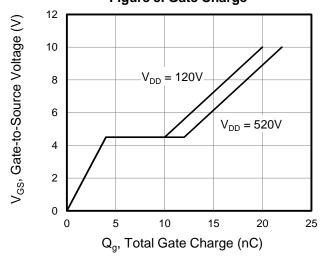
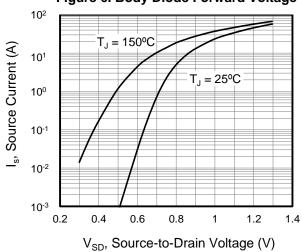


Figure 6. Body Diode Forward Voltage





Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

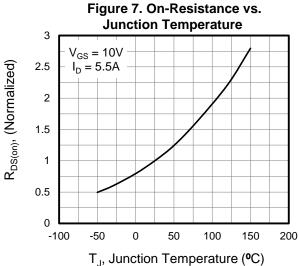


Figure 9. Transient Thermal Impedance
TO-252/TO-220/TO-251

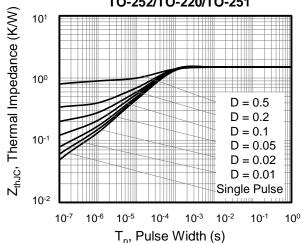


Figure 8. Threshold Voltage vs. **Junction Temperature** $I_{D} = 250 \mu A$ 0.4 V_{GS(th)}, (Variance) 0 -0.4 -0.8 -1.2 -100 -50 50 100 150 200 T_J, Junction Temperature (°C)

Figure 10. Transient Thermal Impedance **TO-220F** 10¹ Z_{thJC}, Thermal Impedance (K/W) 100 D = 0.5D = 0.2D = 0.110-1 D = 0.05D = 0.02D = 0.01Single Pulse 10-2 10-5 10-4 10-2 10⁰ 10¹ T_p, Pulse Width (s)

V1.0 4 www.tsinghuaicwx.com



Figure A: Gate Charge Test Circuit and Waveform

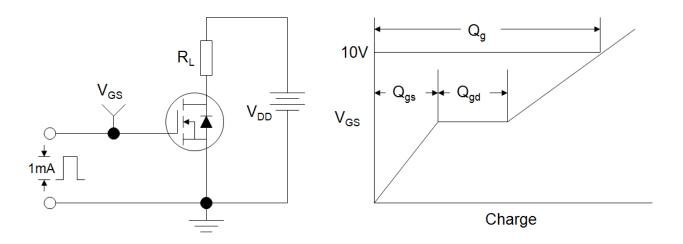


Figure B: Resistive Switching Test Circuit and Waveform

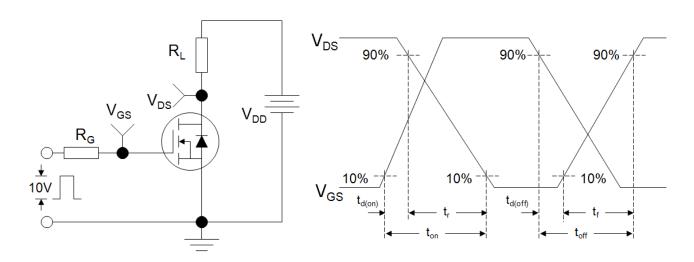
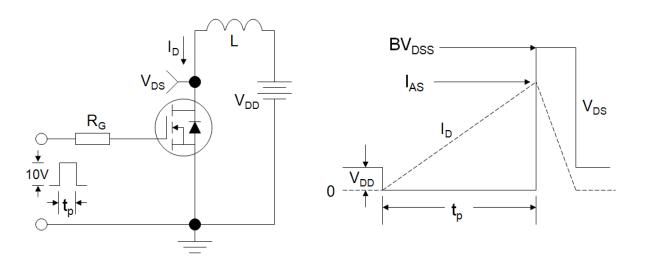


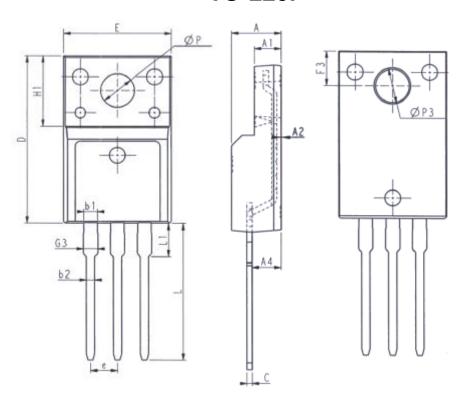
Figure C: Unclamped Inductive Switching Test Circuit and Waveform



V1.0 5 www.tsinghuaicwx.com

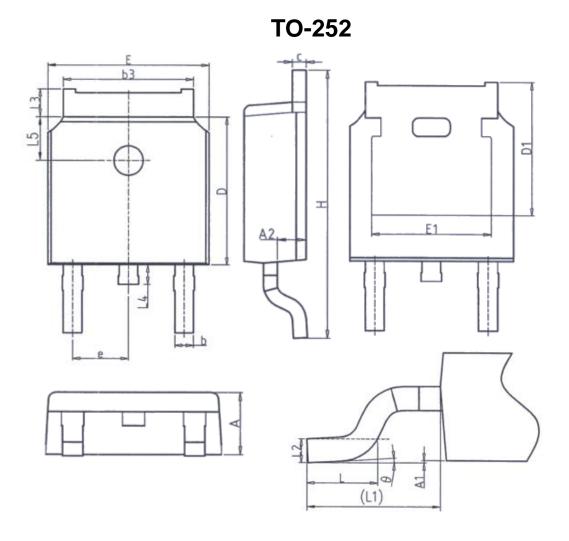






l	Unit: mm			Jnit: mm	1
Symbol	Min.	Max.	Symbol	Min.	Max.
E	9.96	10.36	L	12. 68	13. 28
Α	4. 50	4. 90	L1	2. 93	3. 13
A 1	2. 34	2. 74	Р	3. 03	3. 38
A2	0. 30	0.60	Р3	3. 15	3. 65
A4	2. 56	2. 96	F3	3. 15	3. 45
С	0.40	0. 65	G3	1. 25	1. 55
D	15. 57	16. 17	b1	1. 18	1. 43
H1	6. 70REF		b2	0. 70	0. 95
е	2. 54BSC				



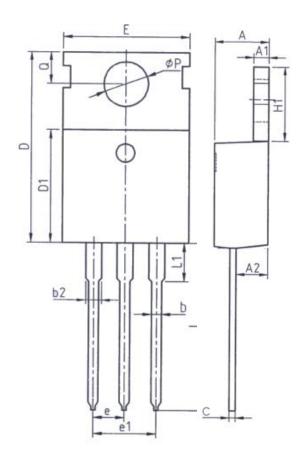


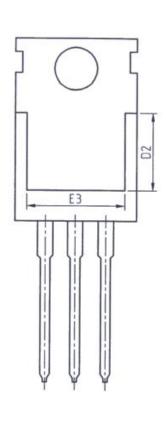
Unit: mm						
Symbol	Min.	Max.				
Α	2. 20	2. 40				
A1	0.00	0. 20				
A2	0. 97	1. 17				
b	0. 68	0. 90				
b3	5. 20	5. 50				
С	0. 43	0. 63				
D	5. 98	6. 22				
D1	D1 5. 30REF					
E	6. 40	6. 80				
E1	4. 63	_				

Unit: mm					
Symbol	Min.	Max.			
е	2. 28	6BSC			
Н	9. 40	10.50			
L	1. 38	1. 75			
L1	2. 90REF				
L2	0. 51	IBSC			
L3	0.88	1. 28			
L4	- 1.00				
L5	1. 65	1. 95			
θ	0°	8°			



TO-220

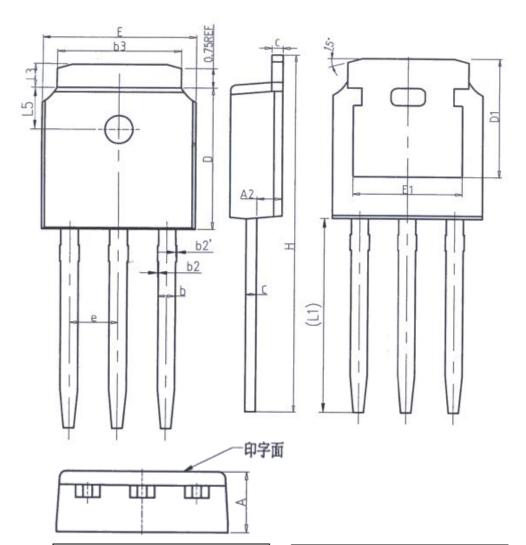




Unit: mm					
Symbol	Min.	Max.			
Α	4. 37	4. 77			
A1	1. 25	1. 45			
A2	2. 20	2. 60			
b	0. 70	0. 95			
b2	1. 17	1. 47			
С	0. 40	0. 65			
D	15. 10	16. 10			
D1	8. 80	9. 40			
D2	5. 50	_			

Unit: mm					
Symbol	Min.	Max.			
E	9. 70	10. 30			
E3	7. 00	-			
е	2. 54BSC				
e1	5. 08BSC				
H1	6. 25	6. 85			
L	12. 75	13.80			
L1	-	3. 40			
P	3. 40	3. 80			
Q	2. 60	3. 00			

TO-251



Unit: mm					
Symbol	Min.	Max.			
Α	2. 20	2. 40			
A2	0. 97	1. 17			
b	0. 68	0.90			
b2	0.00	0.10			
b2′	0.00	0.10			
b3	5. 20	5. 50			
С	0. 43	0. 63			
D	5. 98	6. 22			

Unit: mm					
Symbol	Min.	Max.			
D1	5. 30	REF			
E	6. 40	6. 80			
E1	4. 63	-			
е	2. 28	6BSC			
Н	16. 22	16. 82			
L1	9. 15	9. 65			
L3	0.88	1. 28			
L5	1. 65	1. 95			





Disclaimer

All product specifications and data are subject to change without notice.

For documents and material available from this datasheet, Wuxi Unigroup does not warrant or assume any legal liability or responsibility for the accuracy, completeness of any product or technology disclosed hereunder.

No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document or by any conduct of Wuxi Unigroup.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling Wuxi Unigroup products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Wuxi Unigroup for any damages arising or resulting from such use or sale.

Wuxi Unigroup disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Wuxi Unigroup's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

Wuxi Unigroup Microelectronics CO., LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all Wuxi Unigroup products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

Information (including circuit diagrams and circuit parameters) herein is for example only. It is not guaranteed for volume production. Wuxi Unigroup believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

V1.0 www.tsinghuaicwx.com